IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: HARA, Shoji et al.

Group Art Unit: 1762

Serial No.: 09/782,169

Examiner: Brian K. Talbot

Filed: February 14, 2001

P.T.O. Confirmation No.: 2107

For:

Laminate Comprising Polyimide and Conductor Layer, Multi-Layer Wiring Board

with the Use of the Same and Process for Producing the Same

AMENDMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated February 21, 2002, please amend the aboveidentified application as follows:

IN THE SPECIFICATION:

Please amend the specification as follows: